Preliminary Data Sheet



Bipolar Analog Integrated Circuit $\mu PC3230GR$

AGC AMPLIFIER + PRE AMPLIFIER IC

DESCRIPTION

The uPC3230GR is silicon bipolar monolithic IC designed for use as Dual path AGC amplifier for digital TV, Digital CATV.

This IC consists of Dual path AGC amplifier for QAM path and analog one to B/B block of STB.

The package is 16-pin SSOP Package suitable for surface mount.

This IC is manufactured using our 30 GHz fmax UHS0 (Ultra High Speed Process) silicon bipolar process.

This process uses silicon nitride passivation film. This material can protect chip surface from external pollution and prevent corrosion /migration. Thus, this IC has excellent performance, uniformly and reliability.

FEATURES

· f(in):30~100MHz

AGC AMPLIFIERBLOCK

- · ICC:37mA @5.0V
- · Gmax:30dB
- · GCR:40dB
- · IM3:45dBc(min)/53dB(typ)@Output=0.5Vp-p/tone

PRE AMPLIFIER BLOCK

- · ICC:61mA @5.0V
- · Gain :28dB(typ)
- NF :6.6dB(typ)
- · IM3:58dB(typ)@Output=2.5Vp-p/tone

Package

High-density surface mounting: 16-pin SSOP package (5.2×4.4×1.5mm)

APPLICATIONS

- · Digital CATV
- · Cable modem receivers

ORDERING INFORMATION (PLAN)

Part Number	Package	Supplying Form
μPC3230GR-E1-A	16-pin plastic SSOP (5.72mm(225))	Embossed tape 12mm wide.
	(Pb-Free) Note	Pin 1 indicates pull-out direction of tape.
		Qty 2.5kpcs/reel.

Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, please contact your local NEC sales office.

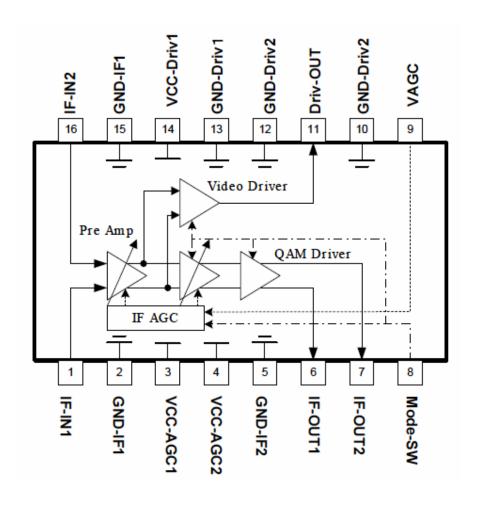
Part number for sample order: µPC3230GR

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INTERNAL BLOCK DIAGRAM AND PIN CONFIGURATION

(Top View)



ABSOLUTE MAXIMUM RATINGS

Parameter	Parameter Symbol Test Condition		Rating	Unit
Supply Voltage	V _{cc}	T _A =+25°C	6.0	V
Power Dissipation	P _D	T _A =+70°C Note	533	mW
Operating Ambient Temperature	T _A		-20 to +70	°C
Storage Temperature	T_{stg}		−55 to+150	°C

Note Mounted on double-sided copper-clad 50 \times 50 \times 1.6 mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Unit
Supply Voltage	V _{CC}		4.5	5.0	5.5	V
Operating Ambient Temperature	T _A	V _{cc} = 4.5 to 5.5 V	-20	+25	+70	°C
Gain Control Voltage Range	V_{AGC}		0	-	Vcc	V

ELECTRICAL CHARACTERISTICS

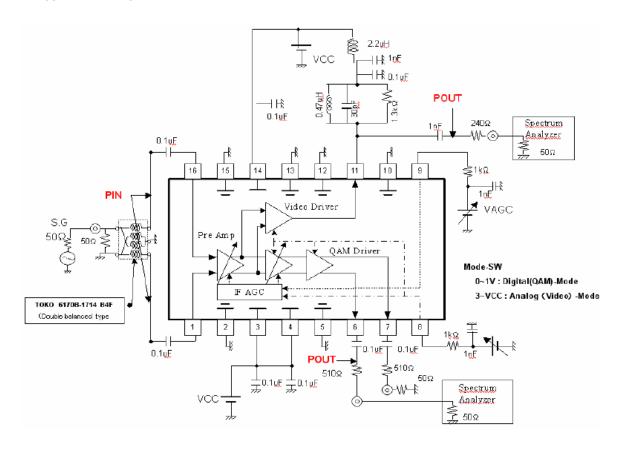
 $(T_A = +25^{\circ}C, V_{CC} = 5V, f = 45MHz, Z_{in} = 50 \Omega, Z_{out} (11pin) = 290 \Omega, Z_{out} (6.7pin) = 560 \Omega)$

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit	
Input Frequency Range	f _(in)	f _c =-3dB Note 1		30	-	100	MHz
Mode Switch voltage range	V _{SW1}	Digital (QAM) Mode		0	-	1	V
	V _{SW2}	Analog (Video) Mode		3	-	Vcc	V
Digital (QAM) Mode V _{SW} =1.0							
Circuit Current	Icc ₁	no input signal	Note 1	-	37	48	mA
Maximum Voltage Gain	G _{MAX}	V _{AGC} =2.5V,Dual-IN:V _{ou} =+18dBmV	Note 1	27	30	33	dB
Gain Control Range	GCR _{in}	V _{AGC} =0 to 2.5 V	Note 1	35	40	-	dB
(input prescribe)							
3rd Order Inter-modulation	IM ₃₁	f ₁ = 44 MHz, f ₂ = 45 MHz,		45	53	-	dBc
Distortion		V _{in} = +30 dBmV/tone,					
		V _{out} =0.5V _{P-P} /tone	Note 1				
Noise Figure	NF ₁	V _{AGC} = 2.5 V f=45MHz	Note 2	-	6.0	-	dB
Output Voltage	V _{out1}	f=45MHz , 6pin	Note 1	-	1.0	-	V _{P-P}
Output Voltage	V _{out2}	f=45MHz , 7pin	Note 1	-	1.0	-	V _{P-P}
AGC Voltage High Level	V _{AGC(H)}	@ Maximum gain Note 1		2.5	-	Vcc	V
Analog (Video) Mode V _{SW} =	=3.0V Z _{L2} =2	90 Ω					
Circuit Current	Icc ₂	no input signal	Note 1	-	61	79	mA
Pre Amp Voltage Gain	G _V	V _{AGC} =2.5V,Dual-IN:V _{ou} =+18dBmV	Note 1	25	28	31	dB
Pre Amp Noise Figure	NF ₂	V _{AGC} = 2.5 V, f=45MHz	Note 2	-	6.6	-	dB
3rd Order Inter-modulation	IM ₃₂	f ₁ = 44 MHz, f ₂ = 45 MHz,		44	58	-	dBc
Distortion		P _{in} = –22 dBm/tone,					
		V _{out} =2.5V _{P-P} /tone	Note 1				
Output Voltage	V _{out3}	Dual-IN:V _{ou} =+27dBmV, 11pin	Note 1	1.3	2.0	2.5	V _{P-P}

Notes 1. By measurement circuit 1

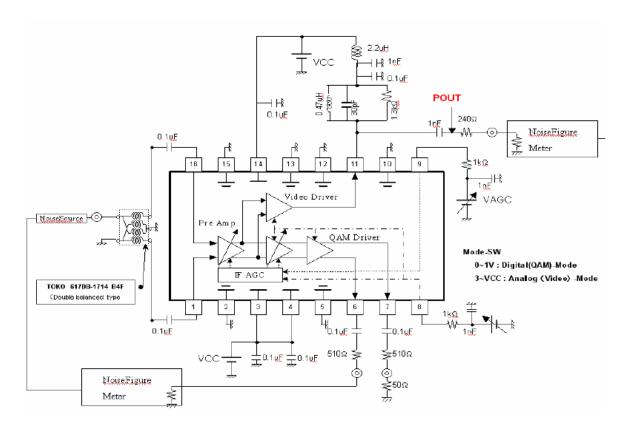
2. By measurement circuit 2

MEASUREMENT CIRCUIT 1



Note Balun Transformer: TOKO 617DB-1714 B4F (Double balanced type)

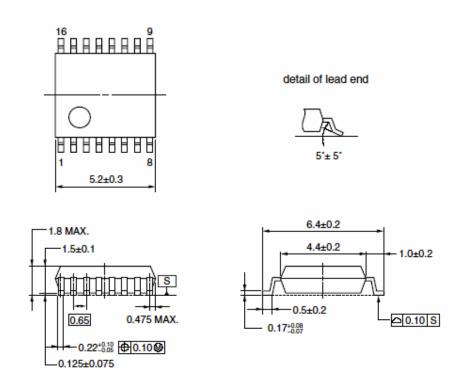
MEASUREMENT CIRCUIT 2



Note Balun Transformer: TOKO 617DB-1714 B4F (Double balanced type)

PACKAGE DIMENSIONS

16 PIN PLASTIC SSOP (5.72mm(225)) (Unit: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
VPS	Peak temperature (package surface temperature) Time at temperature of 200°C or higher Preheating time at 120 to 150°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 215°C or below : 25 to 40 seconds : 30 to 60 seconds : 3 times : 0.2%(Wt.) or below	VP215
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS280
Partial Heating	Peak temperature (pin temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

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